

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Tanu Suryadi KUSTANDI</td> <td>06/10/2009</td> </tr> <tr> <td>Hong Yee LOW</td> <td>06/10/2009</td> </tr> <tr> <td>Isabel RODRIGUEZ FERNANDEZ</td> <td>06/10/2009</td> </tr> </tbody> </table>		Name	Execution Date	Tanu Suryadi KUSTANDI	06/10/2009	Hong Yee LOW	06/10/2009	Isabel RODRIGUEZ FERNANDEZ	06/10/2009		
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Agency for Science, Technology and Research</td> </tr> <tr> <td>Street Address:</td> <td>1 Fusionopolis Way, #20-10, Connexis</td> </tr> <tr> <td>City:</td> <td>Singapore</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>138632</td> </tr> </table>		Name:	Agency for Science, Technology and Research	Street Address:	1 Fusionopolis Way, #20-10, Connexis	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	138632
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CORRESPONDENCE DATA											
<p>Fax Number: (713)228-8778</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 713-228-8600</p> <p>Email: mcfadden@oshaliang.com</p> <p>Correspondent Name: Jeffrey S. Bergman</p> <p>Address Line 1: TWO HOUSTON CENTER</p> <p>Address Line 2: 909 FANNIN, SUITE 3500</p> <p>Address Line 4: HOUSTON, TEXAS 77010</p>											
ATTORNEY DOCKET NUMBER:	17442/017001 (BCM)										
NAME OF SUBMITTER:	Jeffrey S. Bergman										
<p>Total Attachments: 3</p> <p>source=017001_assignment_20101210084328#page1.tif</p>											

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PATENT
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DEED OF ASSIGNMENT

THIS DEED made the 10th day of June two thousand and nine (2009)
BETWEEN,

- (1) KUSTANDI, Tanu Suryadi of
c/o Institute of Materials Research and Engineering
3 Research Link
Singapore 117602
- (2) LOW, Hong Yee of
c/o Institute of Materials Research and Engineering
3 Research Link
Singapore 117602
- (3) RODRÍGUEZ FERNÁNDEZ, Isabel of
c/o Institute of Materials Research and Engineering
3 Research Link
Singapore 117602

[hereinafter referred to as "the Assignors"]

AND

- (1) AGENCY FOR SCIENCE, TECHNOLOGY AND RESEARCH
1 Fusionopolis Way, #20-10, Connexis
Singapore 138632

[hereinafter referred to as "the Assignee"]

WHEREAS the Assignors warrant that the Assignors are the inventors of an invention relating to an invention entitled "**Method of Making A Substrate Having Multi-Layered Structures**" [hereinafter referred to as "the Invention"], the subject of International Patent Application No. PCT/SG2009/000208, including the designation of the United States of America [hereinafter referred to as "the Application"]

AND WHEREAS the Assignors have agreed to assign to the Assignee and the Assignee desires to take assignment of all rights, title and interest of the Assignors in and to the Invention and the Application,

NOW THIS DEED WITNESSETH

1. In consideration of the sum of one dollar (\$1) and other good and valuable consideration receipt of which is hereby acknowledged by the Assignors, the Assignors hereby assign to the Assignee all of his rights, title and interest in and to the Invention and the Application including:

- (a) all rights and powers to make one or more applications for Letters Patent or other form of protection in the name of the Assignee in Singapore, the United States of America and in any other country of the world in respect of the Invention, and all rights, title and interest in and to any Letters Patent or other form of protection to mature from any such application,
- (b) the rights and powers to prosecute the Application and all rights, title and interest in and to any Patent or Patents granted thereon together with any extension of the term of any such Patent or Patents as may be granted, SAVE THAT nothing in this Deed shall prevent the filing or proceeding of an Application to which this Deed relates, in the name of the Assignors or Inventors where such filing or proceeding of such Application is beneficial to the interests of the Assignee
- (c) the rights and powers to seek protection in countries other than Singapore by way of Patent, Petty Patent, Utility Model, Design Patent or other appropriate form of protection for the Invention, by way of application(s) for such protection made to the appropriate authorities in such other country or countries as the Assignee in its complete discretion may elect, whether or not any such foreign application(s) be made claiming International Convention priority from the Application hereby assigned
- (d) any Copyright owned by the Assignors in and to any drawings relating to the subject matter of the Invention together with the rights and powers such as subsist at the date of this Deed
- (e) to apply for registration of Copyright, Design, Design-Patent or like protection in the name of the Assignee in Singapore and in any other country of the world in respect of the subject matter of the said drawings and to any registration of Copyright, Design-Patent or like protection which matures from any such application, together with the rights to sue in respect of any infringement of that Copyright which may have occurred before the date of this Deed


2. The Assignors agree, at the expense of the Assignee, to sign, execute and deliver all documents, forms and papers reasonably required to be produced or obtained by the Assignee in connection with any application for Letters Patent or other form of protection for the subject matter of the Invention, in Singapore or elsewhere.


IN WITNESS WHEREOF the Assignors and Assignee executed this Deed the day and year first hereinbefore written.

ASSIGNORS

SIGNED, SEALED and DELIVERED

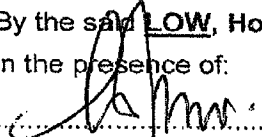
By the said KUSTANDI, Tanu Suryadi
in the presence of:

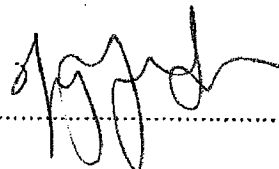

.....
(Witness) Loh Wei Wei


.....

SIGNED, SEALED and DELIVERED

By the said LOW, Hong Yee
in the presence of:

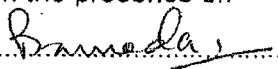

.....
(Witness) Tan Cili

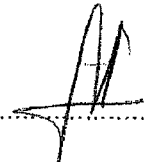

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SIGNED, SEALED and DELIVERED

By the said RODRÍGUEZ FERNÁNDEZ,
Isabel

in the presence of:


.....
(Witness)

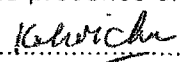

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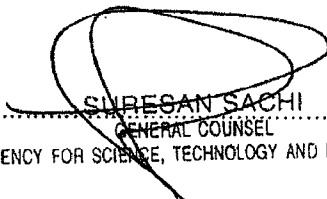
ASSIGNEE

FOR AND ON BEHALF OF

By the said **AGENCY FOR SCIENCE,
TECHNOLOGY AND RESEARCH**

in the presence of:


.....
(Witness)


.....
SURESAN SACHI
GENERAL COUNSEL
AGENCY FOR SCIENCE, TECHNOLOGY AND RESEARCH